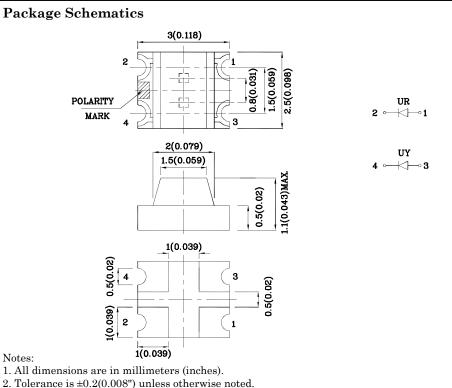


3.0x2.5mm SURFACE MOUNT LED LAMP

Features

- \bullet Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 2000pcs / reel
- \bullet Moisture sensitivity level : level 3
- \bullet RoHS compliant





3. Specifications are subject to change without notice.

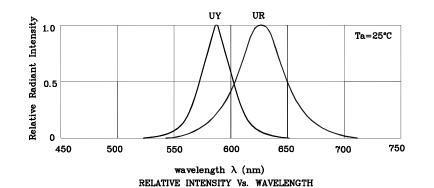
Absolute Maximum Ratings (T _A =25°C)		UR (GaAsP/ GaP)	UY (GaAsP/ GaP)	Unit
Reverse Voltage	V_{R}	5	5	V
Forward Current	$I_{\rm F}$	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	160	140	mA
Power Dissipation	P_{D}	75	75	mW
Operating Temperature	TA	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		-0

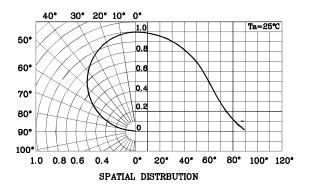
Operating Characteristics (T _A =25°C)		UR (GaAsP/ GaP)	UY (GaAsP/ GaP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2	2.1	v
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.5	2.5	v
Reverse Current (Max.) (V _R =5V)	I_{R}	10	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λP	627	590	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	625	588	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle\lambda$	45	35	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	20	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZURUY57W	Red	GaAsP/GaP	Water Clear -	8	14	627	120°
	Yellow	GaAsP/GaP		5	9	590	

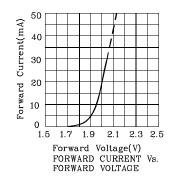
XDSA1563 V6 Layout: Maggie L.

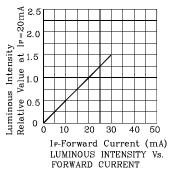


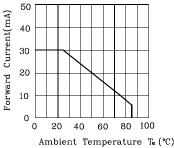


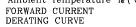


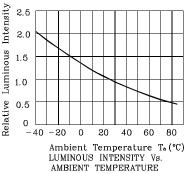
♦ UR



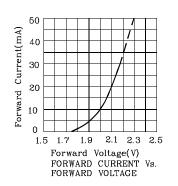


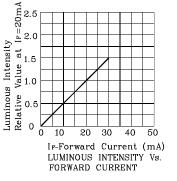


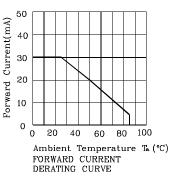


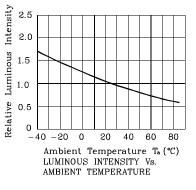


♦ UY











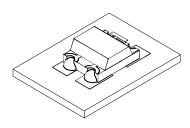
LED is recommended for reflow soldering and soldering profile is shown below.

The device has a single mounting surface. The device must be mounted according to the specifications.

300 (°C) 10 8 250 4°C/s C/s r 200 150~180°C 4℃/s max 150 Temperature 80~120 100 50 100 150 200 250 300 (sec) Tim Notes Maximum soldering temperature should not exceed 260°C

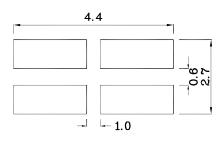
Reflow Soldering Profile for SMD Products (Pb-Free Components)

- Maximum soldering temperature should not exceed 260°C
 Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

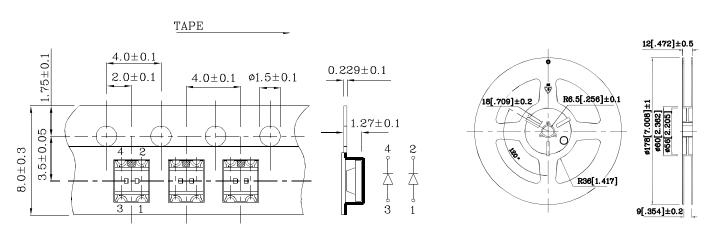


Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 25,2011



PACKING & LABEL SPECIFICATIONS

